

## Introduction

The ISL8106EVAL1Z evaluation board demonstrates the performances of the ISL8106, synchronous buck PWM controller with Intersil's Robust Ripple Regulator (R3) technology.

The ISL8106 features a 1.5ms digital soft-start and can be started into a pre-biased output voltage. The PWM switching frequency can be programmed from 200kHz to 600kHz. The ISL8106 can be configured to operate in Forced-Continuous-Conduction-Mode (FCCM) or in Diode-Emulation-Mode (DEM), which improves light-load efficiency. An audio filter prevents the PWM switching frequency from entering the audible spectrum due to extremely light load while in DEM. Refer to the ISL8106 data sheet for a more detailed operation by clicking on the following link.

<http://www.intersil.com/data/fn/fn9283.pdf>

## ISL8106EVAL1Z Reference Design

The ISL8106EVAL1Z design criteria is listed in Table 1.

**TABLE 1. ISL8106EVAL1Z DESIGN CRITERIA**

PARAMETERS	VALUE
Input Voltage	7V to 25V
Output Voltage	1.8V
Rated Output Current	25A
Switching Frequency	300kHz

### Setting Switching Frequency

The switching frequency of ISL8106EVAL1Z can be adjusted through the resistor, R<sub>5</sub>, that is connected from the FSET pin to the GND pin. Programming the approximate PWM switching frequency can be estimated from Equation 1:

$$R_{FSET} = \frac{1}{60 \cdot F_{OSC} \cdot [1 \times 10^{-12}]} \quad (\text{EQ. 1})$$

### Setting Overcurrent Protection Threshold

An overcurrent protection fault will occur when the ISEN pin has measured more than the OCP threshold current I<sub>OC</sub> (26μA, typ.), on consecutive PWM pulses, for a period exceeding 20μs. It does not matter how many PWM pulses are measured during the 20μs period. If a measurement falls below I<sub>OC</sub> before 20μs has elapsed, then the timer is reset to zero. A short circuit protection fault will occur when the ISEN pin has measured more than the short-circuit threshold current I<sub>SC</sub>, in less than 10μs, on consecutive PWM pulses.

The value of R<sub>SEN</sub> can then be calculated by Equation 2:

$$R_{SEN} = \frac{\left[ I_{FL} + \frac{I_{P-P}}{2} \right] \cdot OC_{SP} \cdot r_{DS(ON)}}{I_{OC}} \quad (\text{EQ. 2})$$

Where:

- R<sub>SEN</sub> (Ω) is the resistor used to program the overcurrent setpoint
- I<sub>OC</sub> is the I<sub>SEN</sub> threshold current value sourced from the ISEN pin that will activate the OCP circuit
- I<sub>FL</sub> is the maximum continuous DC load current
- I<sub>P-P</sub> is the inductor peak-to-peak ripple current
- OC<sub>SP</sub> is the desired overcurrent setpoint expressed as a multiplier relative to I<sub>FL</sub>

## Power and Load Connections

### INPUT VOLTAGE

The PVIN post (J1) is connected to the drain of the upper MOSFET and the VIN pin of the IC. The post (J2) is connected to PGND.

### OUTPUT VOLTAGE LOADING AND MONITORING

Connect the positive and negative leads of an electronic load to J3 and J4 respectively. Terminal TP4 (PGND) and TP5 (V<sub>OUT</sub>) can be used to measure the output voltage.

### Switch Descriptions

**TABLE 2. ISL8106EVAL1Z SWITCH DESCRIPTIONS**

TOGGLE SWITCHES	FUNCTION
SW1	OFF: Shorts the EN pin to GND (Disable the controller) ON: Enable the controller, EN pin is pulled to V <sub>IN</sub> and clamped by D1.
SW2	DEM: FCCM pin is pulled to GND to enable diode-emulation mode FCCM: FCCM pin is pulled to VCC to inhibit diode-emulation mode

### Test-point Descriptions

**TABLE 3. ISL8106EVAL1Z TEST POINT DESCRIPTIONS**

TEST POINTS	SIGNALS
TP1	VCC
TP2	PGND
TP3	PGOOD
TP4	PGND
TP5	VOUT
TP6	PVIN
TP6	LX

Typical Performance Curves

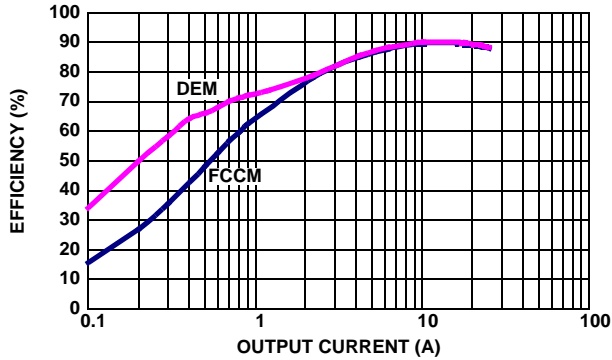


FIGURE 1. EFFICIENCY ( $V_{IN} = 12V$ ,  $V_{OUT} = 1.8V$ ,  $F_{SW} = 300kHz$ )

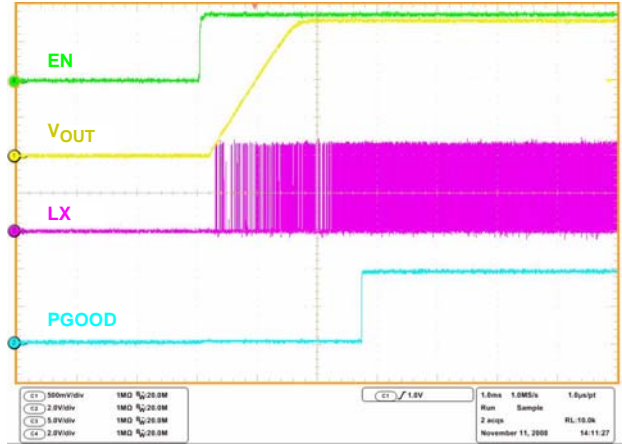


FIGURE 2. SOFT-START: 25A LOAD, FCCM = HIGH

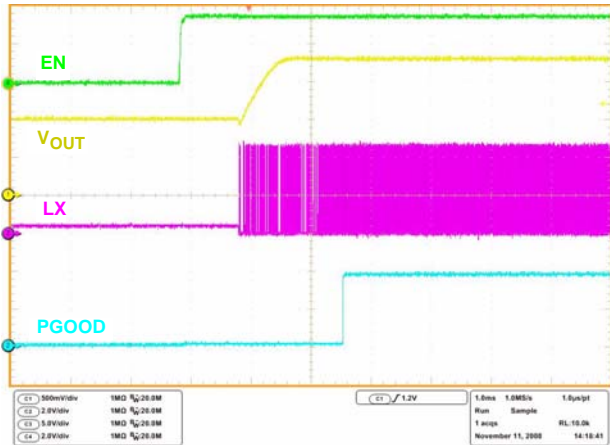


FIGURE 3. PRE-BIASED START-UP (1V PRE-BIASED)

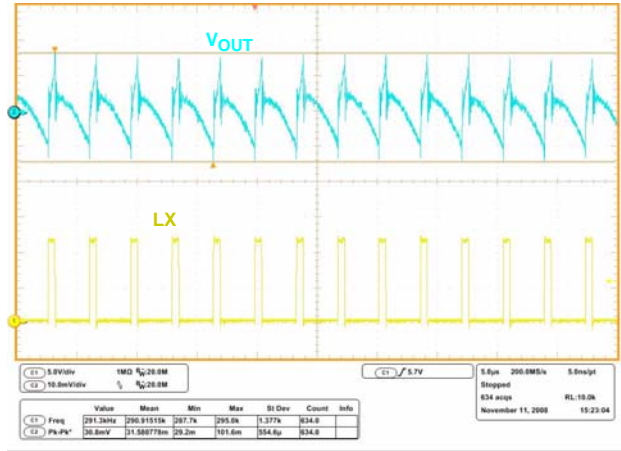


FIGURE 4. STEADY STATE: 25A LOAD

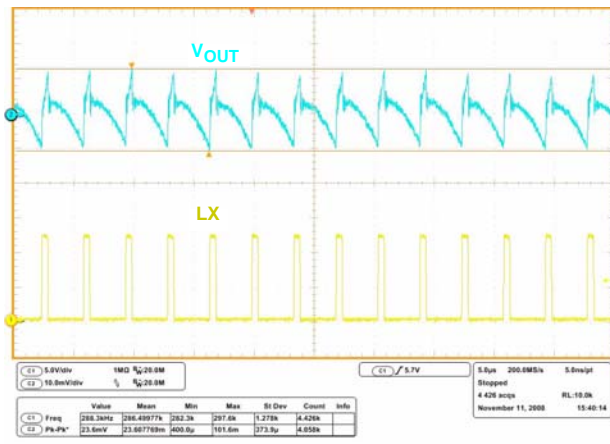


FIGURE 5. STEADY STATE: NO LOAD (FCCM)

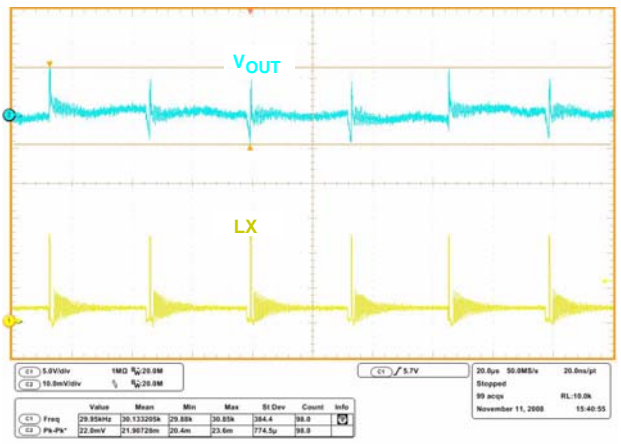


FIGURE 6. STEADY STATE: NO LOAD (DEM)

Typical Performance Curves (Continued)

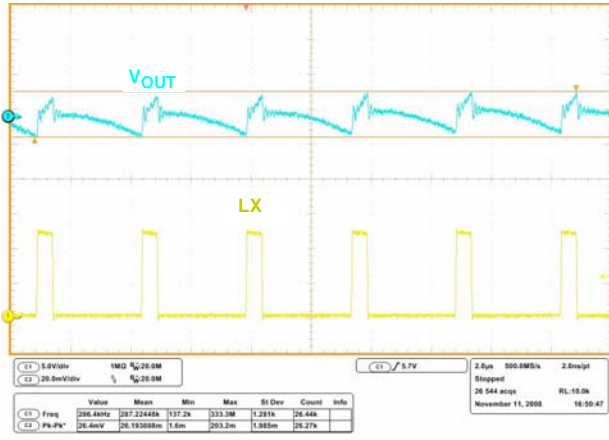


FIGURE 7. STEADY STATE: 1A LOAD (FCM)

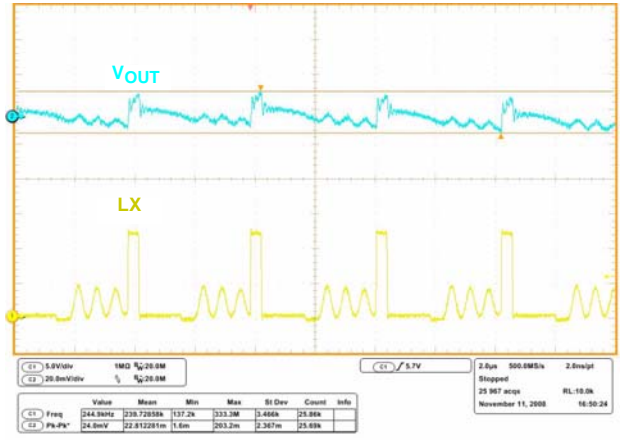


FIGURE 8. STEADY STATE: 1A LOAD (DEM)

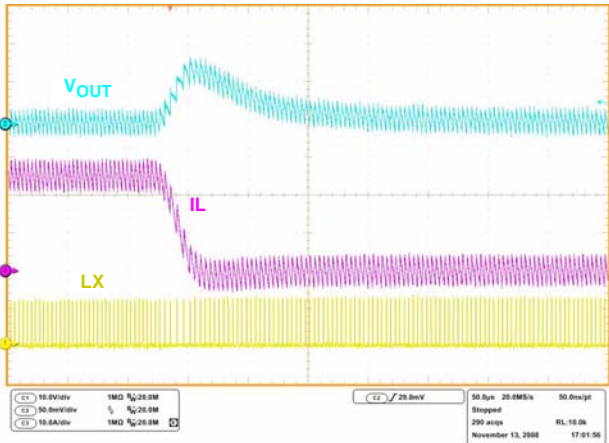


FIGURE 9. LOAD TRANSIENT: 25A TO 0A (CCM)

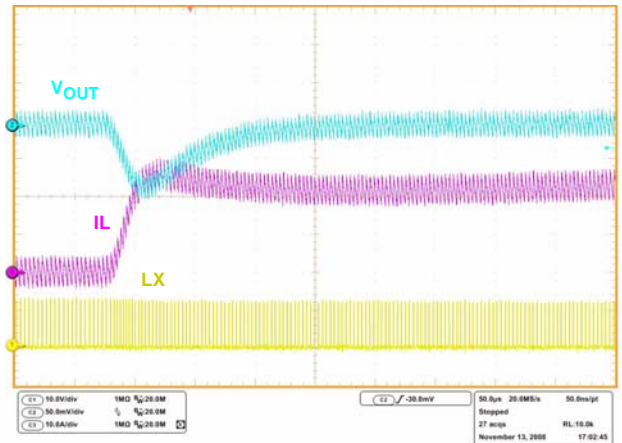


FIGURE 10. LOAD TRANSIENT: 0A TO 25A (CCM)

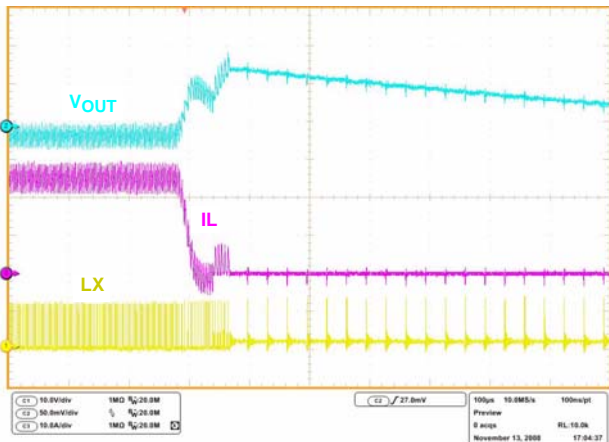


FIGURE 11. LOAD TRANSIENT: 25A TO 0A (DCM-CCM)

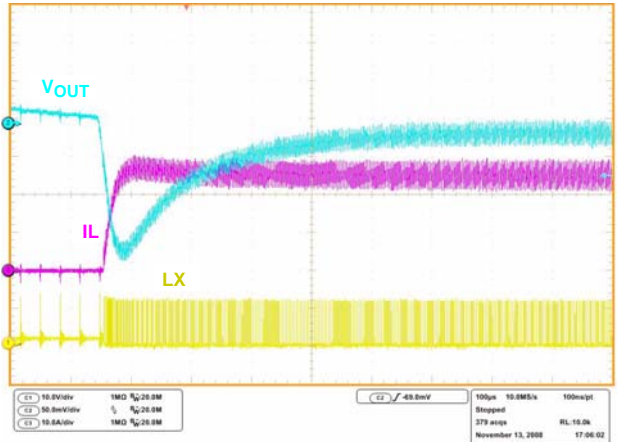
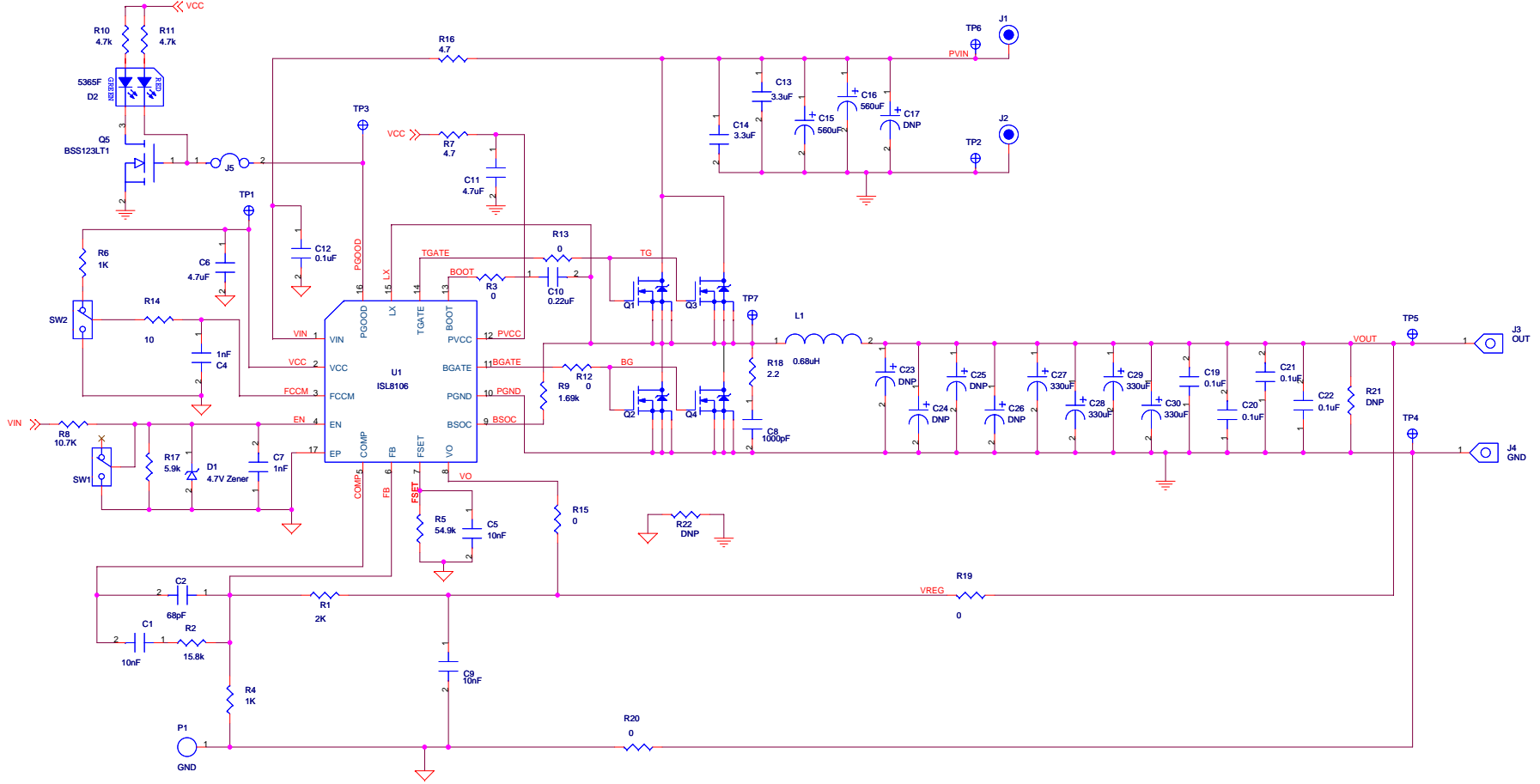


FIGURE 12. LOAD TRANSIENT: 0A TO 25A (CCM-DCM)

# ISL8106EVAL1Z Schematic



## Application Note 1452

### ISL8106EVAL1Z Bill of Materials

ID	REFERENCE	QTY	PART NUMBER	PART TYPE	DESCRIPTION	PACKAGE	VENDOR
1	U1	1	ISL8106IRZ	IC, Linear	IC, Single PWM Controller	16Ld QFN	Intersil
2	Q1, Q3	2	BSC059N04LS G	MOSFET, Single	N-Channel, 40V	TDSON-8	Infineon
3	Q2, Q4	2	BSC018N04LS G	MOSFET, Single	N-Channel, 40V	TDSON-8	Infineon
4	Q5	1	BSS123LT1G	MOSFET	N-Channel	SOT-23	On Semi
5	D1	1	BST52C4V7-7-F	Zener Diode	4.7V, 500mW Zener Diode	SOD-123	Diode Inc.
6	D2	1	SSL-LXA3025IGC-TR	LED	RED/GREEN SMD LED	SMD 3mmx2.5mm	Lumex
7	L1	1	IHLP-5050FD-01-R68-M01	Inductor	0.68μH Power Inductor	SMD	Vishay
<b>CAPACITORS</b>							
8	C15, C16	2	EKZE350ELL561MJ25S	Capacitor, Alum. Elec.	560μF, 20%, 35V	RAD 10x25	United Chemi-con
9	C13, C14	2	C3225X7R1H335M	Capacitor, Ceramic, X7R	3.3μF, 10%, 50V	SM_1210	TDK/Generic
10	C4, C7, C8	3		Capacitor, Ceramic, X7R	1000pF, 10%, 50V	SM_0603	Generic
11	C1, C5, C9	3		Capacitor, Ceramic, X7R	0.01μF, 10%, 50V	SM_0603	Generic
12	C12, C19, C20, C21, C22	5		Capacitor, Ceramic, X7R	0.1μF, 10%, 50V	SM_0603	Generic
13	C10	1		Capacitor, Ceramic, X7R	0.22μF, 10%, 25V	SM_0603	Generic
14	C6, C11	2		Capacitor, Ceramic, X5R	4.7μF, 10%, 6.3V	SM_0603	Generic
15	C27, C28, C29, C30	4	6TPF330M9L	Capacitor, POSCAP	330μF, 20%, 6.3V, 0.009Ω	Case D3L	SANYO
16	C2	1		Capacitor, Ceramic, X5R	68pF, 10%, 50V	SM_0603	Generic
17	C17, C23, C24, C25, C26	0	Do Not Populate				
<b>RESISTORS</b>							
18	R1	1		Resistor, Film	2kΩ, 1%, 1/16W	SM_0603	Panasonic/Generic
19	R2	1		Resistor, Film	15.8kΩ, 1%, 1/16W	SM_0603	Panasonic/Generic
20	R4, R6	1		Resistor, Film	1kΩ, 1%, 1/16W	SM_0603	Panasonic/Generic
21	R21, R22	0	Do Not Populate			SM_0603	
22	R5	1		Resistor, Film	54.9kΩ, 1%, 1/16W	SM_0603	Panasonic/Generic
23	R7, R16	1		Resistor, Film	4.7Ω, 1%, 1/16W	SM_0603	Panasonic/Generic
24	R8	1		Resistor, Film	10.7kΩ, 1%, 1/16W	SM_0603	Panasonic/Generic
25	R3, R12, R13, R15, R19, R20	6		Resistor, Film	0Ω, 1%, 1/16W	SM_0603	Panasonic/Generic
26	R9	1		Resistor, Film	1.69kΩ, 1%, 1/16W	SM_0603	Panasonic/Generic
27	R10, R11	2		Resistor, Film	4.7kΩ, 1%, 1/16W	SM_0603	Panasonic/Generic
28	R14	1		Resistor, Film	10Ω, 1%, 1/16W	SM_0603	Panasonic/Generic
29	R17	1		Resistor, Film	5.9kΩ, 1%, 1/16W	SM_0603	Panasonic/Generic
30	R18	1		Resistor, Film	2.2Ω, 1%, 1/16W	SM_0603	Panasonic/Generic

**ISL8106EVAL1Z Bill of Materials** (Continued)

ID	REFERENCE	QTY	PART NUMBER	PART TYPE	DESCRIPTION	PACKAGE	VENDOR
<b>OTHERS</b>							
31	SW1, SW2	2	GT11MSCKE		Toggle Switch	SMD	C&K
32	P1	1	Do Not Populate				
33	TP1-TP6	6	5002	TEST POINT vertical, white	PC test jack	PTH	Keystone
34	TP7	0	Do Not Populate				
35	J1, J2	2			Blinding Post		
36	J5	1			1X2 Header		
37	J3, J4	2	KPA8CTP		Cable Terminal		BERG/FCI

**ISL8106EVAL1Z Printed Circuit Board Layers**

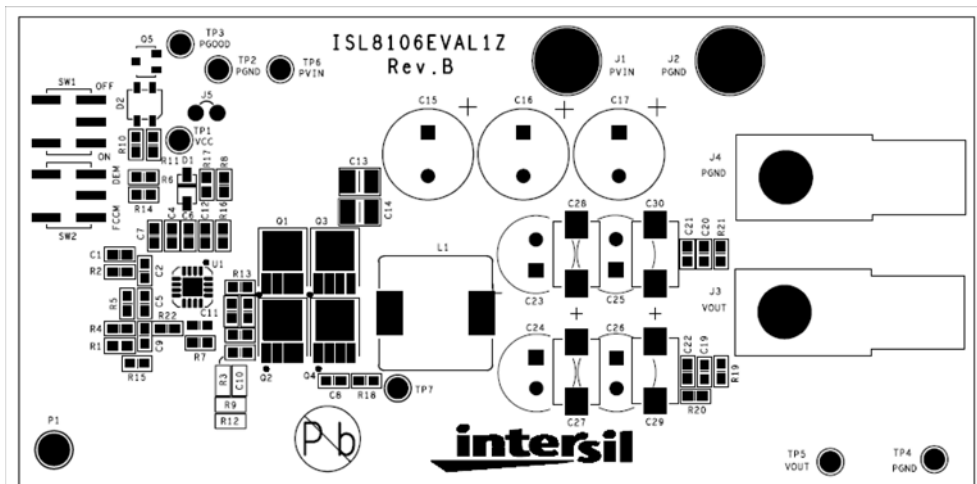


FIGURE 13. ISL8106EVAL1Z - TOP LAYER (SILKSCREEN)

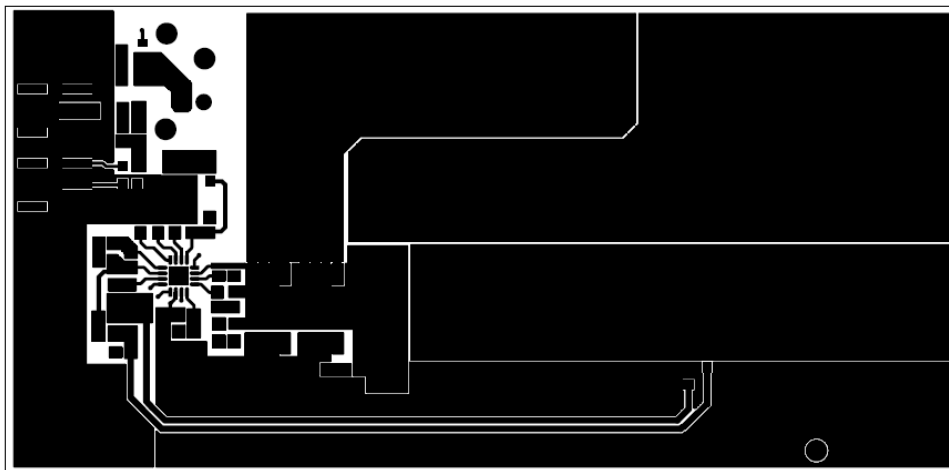


FIGURE 14. ISL8106EVAL1Z - TOP LAYER (COMPONENT SIDE)

ISL8106EVAL1Z Printed Circuit Board Layers (Continued)

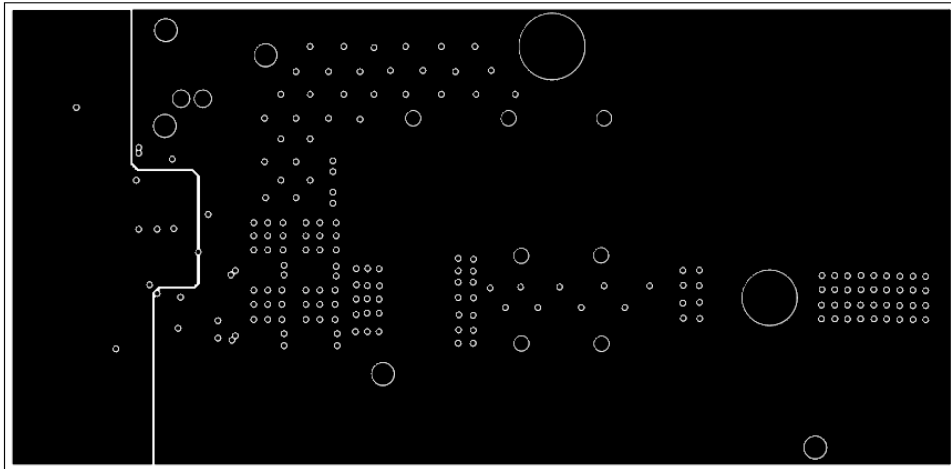


FIGURE 15. ISL8106EVAL1Z - LAYER 2

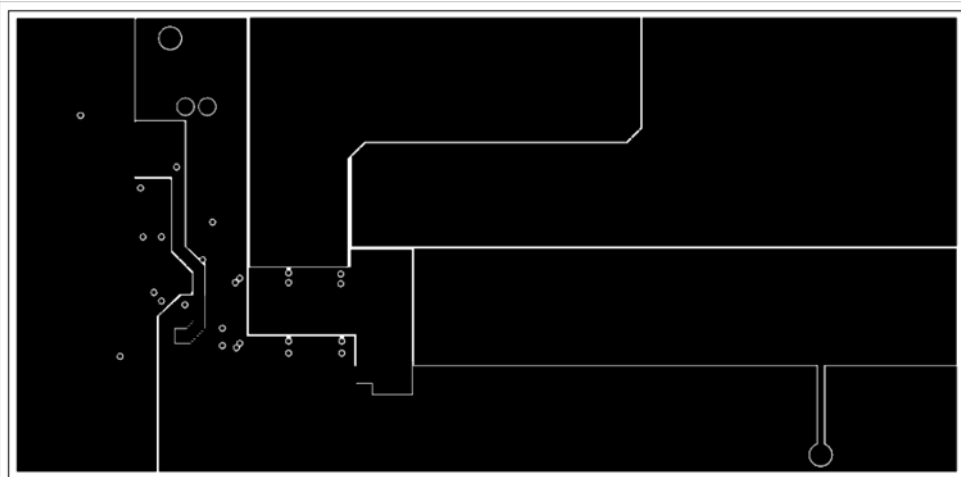


FIGURE 16. ISL8106EVAL1Z - LAYER 3

ISL8106EVAL1Z Printed Circuit Board Layers (Continued)

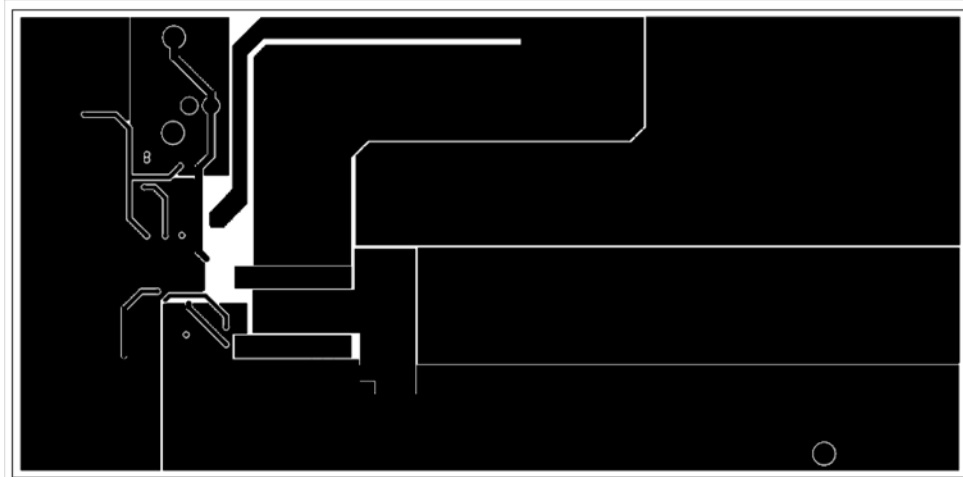


FIGURE 17. ISL8106EVAL1Z - BOTTOM LAYER (SOLDER SIDE)

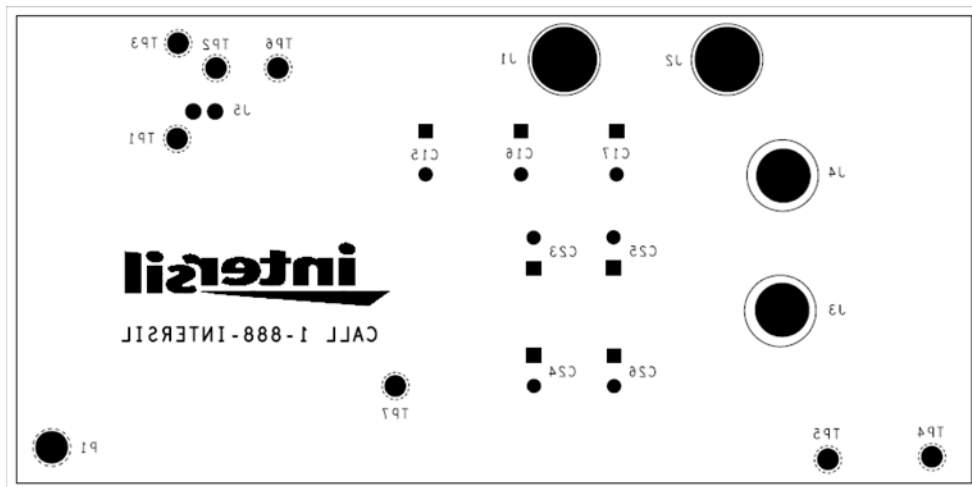


FIGURE 18. ISL8106EVAL1Z - BOTTOM LAYER (SILKSCREEN)

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